# **ON Semiconductor**

## Is Now



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# MBR1240MFS, NRVB1240MFS

# Switch-mode Power Rectifiers

#### **Features**

- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After Board Mounting
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Wettable Flacks Option Available
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

#### **MAXIMUM RATINGS**

| Rating  | Symbol   | Value       | Unit |
|---|--|-------------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                            | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 40          | V    |
| Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 140°C)                                 | I <sub>F(AV)</sub>                                     | 12          | Α    |
| Peak Repetitive Forward Current,<br>(Rated V <sub>R</sub> , Square Wave,<br>20 kHz, T <sub>C</sub> = 138°C)       | I <sub>FRM</sub>                                       | 20          | Α    |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load<br>Conditions Halfwave, Single<br>Phase, 60 Hz) | I <sub>FSM</sub>                                       | 150         | A    |
| Storage Temperature Range   | T <sub>stg</sub>                                       | -65 to +175 | °C   |
| Operating Junction Temperature  | TJ   | -55 to +150 | °C   |
| Unclamped Inductive Switching<br>Energy (10 mH Inductor,<br>Non-repetitive)                                       | E <sub>AS</sub>  | 150         | mJ   |
| ESD Rating (Human Body Model)   |  | 3B          |      |
| ESD Rating (Machine Model)  |  | M4          |      |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: The heat generated must be less than the thermal conductivity from Junction–to–Ambient: dPD/dTJ < 1/RJA.



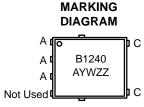
## ON Semiconductor®

http://onsemi.com

# SCHOTTKY BARRIER RECTIFIERS 12 AMPERES 40 VOLTS







B1240 = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

#### **ORDERING INFORMATION**

| Device         | Package              | Shipping†             |
|----------------|----------------------|-----------------------|
| MBR1240MFST1G  | SO-8 FL<br>(Pb-Free) | 1500 /<br>Tape & Reel |
| MBR1240MFST3G  | SO-8 FL<br>(Pb-Free) | 5000 /<br>Tape & Reel |
| NRVB1240MFST1G | SO-8 FL<br>(Pb-Free) | 1500 /<br>Tape & Reel |
| NRVB1240MFST3G | SO-8 FL<br>(Pb-Free) | 5000 /<br>Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# MBR1240MFS, NRVB1240MFS

## THERMAL CHARACTERISTICS

| Characteristic  | Symbol         | Тур           | Max          | Unit |
|---|----------------|---------------|--------------|------|
| Thermal Resistance, Junction–to–Case, Steady State (Assumes 600 mm² 1 oz. copper bond pad, on a FR4 board)  | $R_{	heta JC}$ | -             | 1.7          | °C/W |
| ELECTRICAL CHARACTERISTICS  |                |               |              |      |
| Instantaneous Forward Voltage (Note 1)<br>( $i_F = 12 \text{ A}, T_J = 125^{\circ}\text{C}$ )<br>( $i_F = 12 \text{ A}, T_J = 25^{\circ}\text{C}$ ) | VF             | 0.455<br>0.53 | 0.62<br>0.68 | V    |
| Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T <sub>J</sub> = 125°C) (Rated dc Voltage, T <sub>J</sub> = 25°C)                         | i <sub>R</sub> | 35<br>0.08    | 170<br>0.5   | mA   |

<sup>1.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

## MBR1240MFS, NRVB1240MFS

## **TYPICAL CHARACTERISTICS**

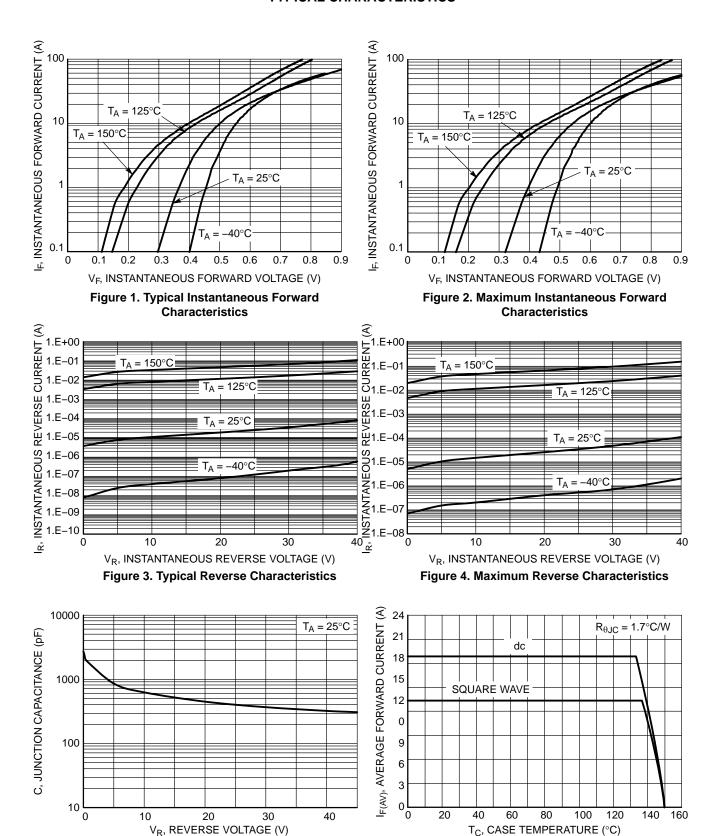
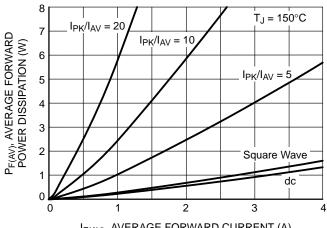


Figure 6. Current Derating TO-220AB

Figure 5. Typical Junction Characteristics

## MBR1240MFS, NRVB1240MFS

## **TYPICAL CHARACTERISTICS**



 $I_{F(AV)}$ , AVERAGE FORWARD CURRENT (A)

Figure 7. Forward Power Dissipation

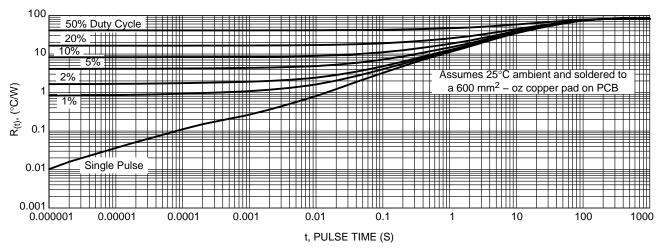


Figure 8.  $R_{(t)}$  vs. Duty



0.10

0.10

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

**DATE 25 JUN 2018** 

#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS

|     | MILLIMETERS |       |      |  |
|-----|-------------|-------|------|--|
| DIM | MIN         | NOM   | MAX  |  |
| Α   | 0.90        | 1.00  | 1.10 |  |
| A1  | 0.00        |       | 0.05 |  |
| b   | 0.33        | 0.41  | 0.51 |  |
| С   | 0.23        | 0.28  | 0.33 |  |
| D   | 5.00        | 5.15  | 5.30 |  |
| D1  | 4.70        | 4.90  | 5.10 |  |
| D2  | 3.80        | 4.00  | 4.20 |  |
| E   | 6.00        | 6.15  | 6.30 |  |
| E1  | 5.70        | 5.90  | 6.10 |  |
| E2  | 3.45        | 3.65  | 3.85 |  |
| е   | 1.27 BSC    |       |      |  |
| G   | 0.51        | 0.575 | 0.71 |  |
| K   | 1.20        | 1.35  | 1.50 |  |
| L   | 0.51        | 0.575 | 0.71 |  |
| L1  | 0.125 REF   |       |      |  |
| М   | 3.00        | 3.40  | 3.80 |  |
| θ   | 0 °         |       | 12 ° |  |

## **GENERIC MARKING DIAGRAM\***



XXXXXX = Specific Device Code

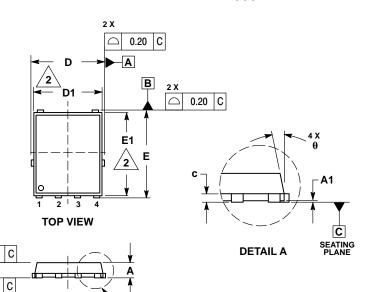
= Assembly Location Α

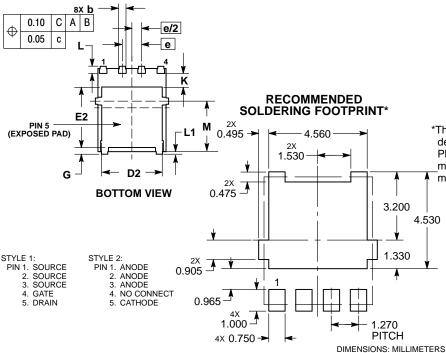
= Lot Traceability

Υ = Year W = Work Week

ZZ

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.





**DETAIL A** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|--------------------------|---|-------------|
| DESCRIPTION:     | DFN5 5x6, 1.27P (SO-8FL) |   | PAGE 1 OF 1 |

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